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Title of Invention:

LEADFRAME TYPE
SEMICONDUCTOR PACKAGE
HAVING REDUCED INDUCTANCE
AND ITS METHOD

First Named Inventor: GI KIM

Domestic/Foreign Application: Domestic Application

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Statement

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TRANSMITTAL

Electronic Version v1.1
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Title of Invention	LEADFRAME TYPE SEMICONDUCTOR PACKAGE HAVING REDUCED INDUCTANCE AND ITS METHOD							
Application Number: 10/766046 								
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First Named Applicant: GI JEONG KIM								
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Submitted by:	Elec. Sign.	Sign. Capacity						
MARK B. GARRED Registered Number: 34,823	/mbg/	Attorney						
Documents being submitted us-ids		Files ids2-usidst.xml us-ids.dtd us-ids.xsl						
Comments								



ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18

Stylesheet Version v18.0

Title of
Invention

LEADFRAME TYPE SEMICONDUCTOR PACKAGE
HAVING REDUCED INDUCTANCE AND ITS METHOD

Application Number: 10/766046



Confirmation Number: 2288

First Named Applicant: GI KIM

Attorney Docket Number: AMKOR099A

Art Unit: 2613

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or 5277972 or 5278446 or 5279029 or 5281849
or 5294897 or 5327008 or 5332864 or 5335771
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or 5474958 or 5484274 or 5493151 or 5508556
or 5517056 or 5521429 or 5528076 or 5534467
or 5539251 or 5543657 or 5544412 or 5545923
or 5581122 or 5592019 or 5592025 or 5594274
or 5595934 or 5604376).pn.

US Patent Documents

Note: Applicant is not required to submit a paper copy of cited US Patent Documents

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Signature

Examiner Name	Date